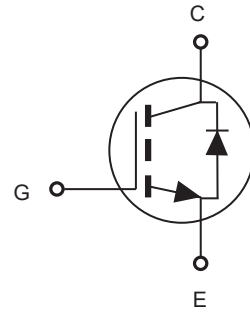
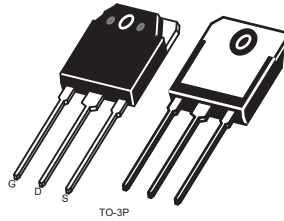


1200V 15A Insulated Gate Bipolar Transistors

FEATURES

- $V_{CES}=1200V$, $I_C=15A$ ($T_C=100^\circ C$) .
- Trench Gate and Field Stop Processes IGBT .
- Low $V_{CE(sat)}$.
- 10us of Short - circuit Withstand Time .



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Limit	Units
Collector-to-Emitter Breakdown Voltage	V_{CES}	1200	V
Gate-to-Emitter Voltage	V_{GE}	± 30	V
Continuous Collector Current @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	I_C	30	A
		15	A
Pulsed Collector Current	I_{CM}	45	A
Maximum Power Dissipation @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	P_D	179	W
		71	W
Operating Junction Temperature	T_J	-40 to 150	$^\circ C$
Storage Temperature Range	T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.7	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ C/W$

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units	
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0V, I_C = 1mA$	1350			V	
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0V$			1	μA	
Gate Body Leakage Current, Forward	I_{GESF}	$V_{GE} = 30V, V_{CE} = 0V$			200	nA	
Gate Body Leakage Current, Reverse	I_{GESR}	$V_{GE} = -30V, V_{CE} = 0V$			-200	nA	
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 1mA$	4.5		6.5	V	
Collector-Emitter saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C = 15A$		1.7	2.2	V	
Input Capacitance	C_{ies}	$V_{CE} = 25V, V_{GE} = 0V,$ $f = 1MHz$		641		pF	
Output Capacitance	C_{oes}			42		pF	
Reverse Transfer Capacitance	C_{res}			22		pF	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 15A,$ $V_{GE} = 15V, R_{GEN} = 5\Omega$ Inductive Load $T_a = 25^\circ\text{C}$		26		ns	
Turn-On Rise Time	t_r			22		ns	
Turn-Off Delay Time	$t_{d(off)}$			161		ns	
Turn-Off Fall Time	t_f			218		ns	
Turn-On Switching Loss	E_{on}			0.7		mJ	
Turn-Off Switching Loss	E_{off}			1		mJ	
Total Gate Charge	Q_g		$V_{CC} = 960V, I_C = 15A,$ $V_{GE} = 15V$		63		nC
Gate-Emitter Charge	Q_{ge}				4		nC
Gate-Collector Charge	Q_{gc}			41		nC	

Electrical Characteristics of Diode $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Diode Forward Voltage	V_F	$I_F = 15A$		1.6	2.1	V
Diode Reverse Recovery Time	t_{rr}	$I_F = 15A$ $di_F / dt = 100A / \mu s$		177		ns
Diode peak Reverse Recovery Current	I_{rr}			9.7		A
Diode Reverse Recovery Charge	Q_{rr}			0.9		μC

Notes :Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.

TYPICAL PERFORMANCE CHARACTERISTICS

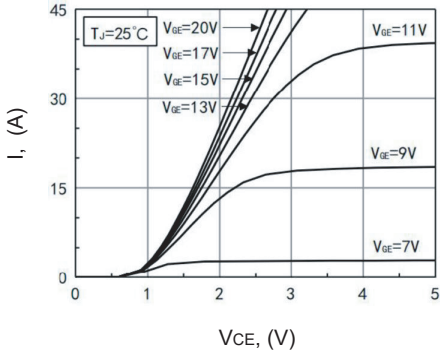


Figure 1. Output Characteristics

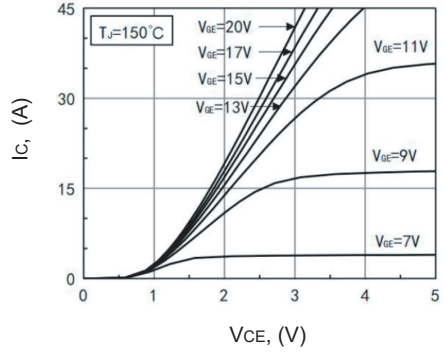


Figure 2. Output Characteristics

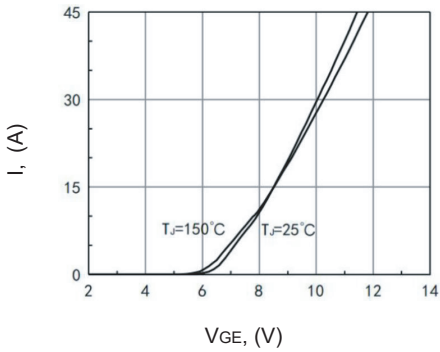


Figure 3. Typical Transfer Characteristics

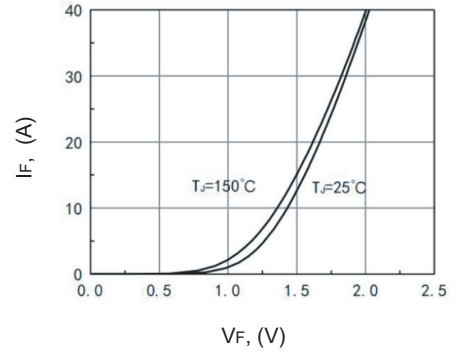


Figure 4. Saturation Voltage vs Tc Characteristics

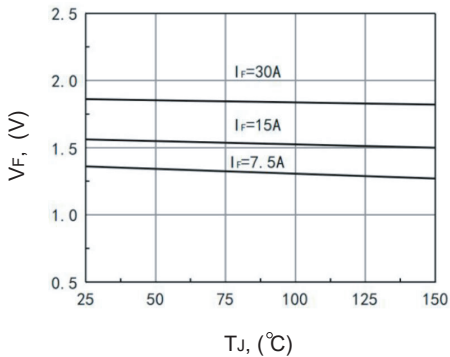


Figure 5. Forward Voltage vs Junction Temperature

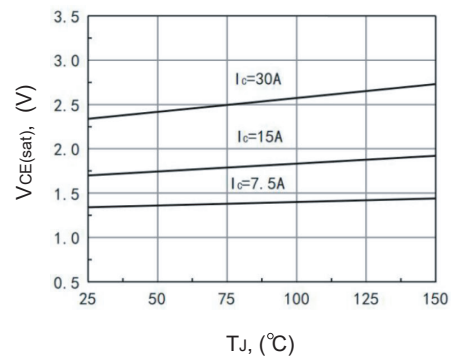


Figure 6. Typical $V_{CE(sat)}$ vs T_J Characteristics

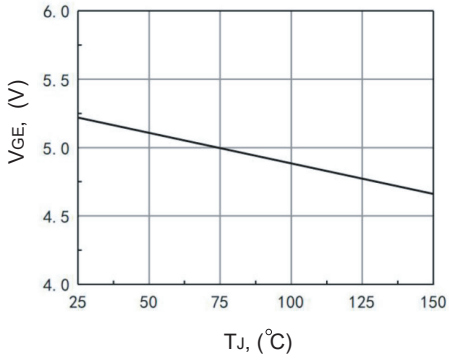


Figure 7. $V_{GE(th)}$ vs T_J Characteristics

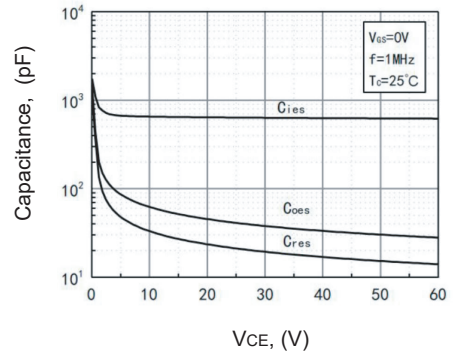


Figure 8. Capacitance Characteristics

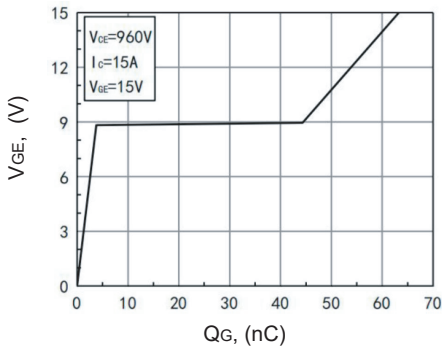


Figure 9. Gate Charge Wave Form

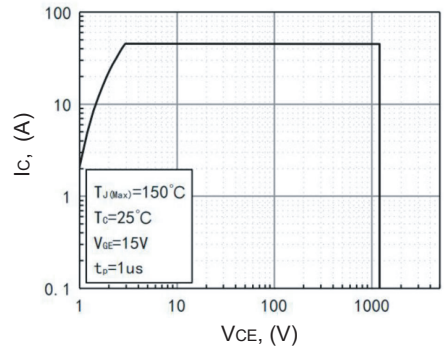


Figure 10. Forward Bias Safe Operating Area

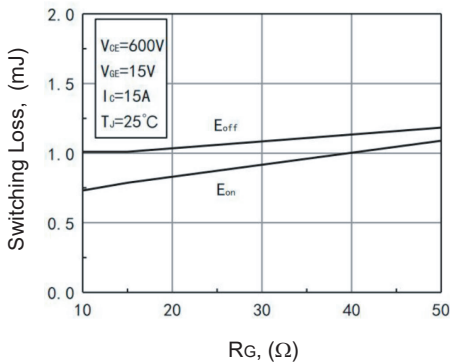


Figure 11. Switching Loss vs Gate Resistances

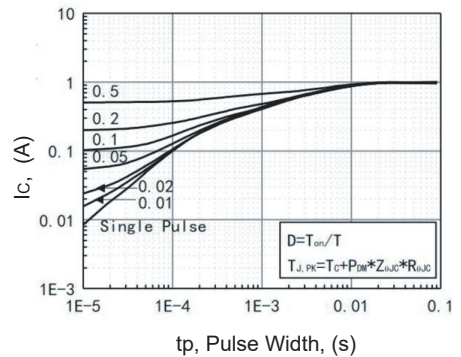
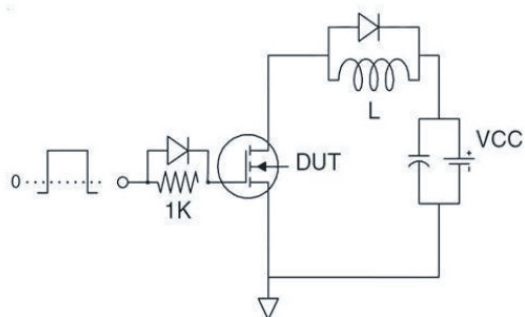
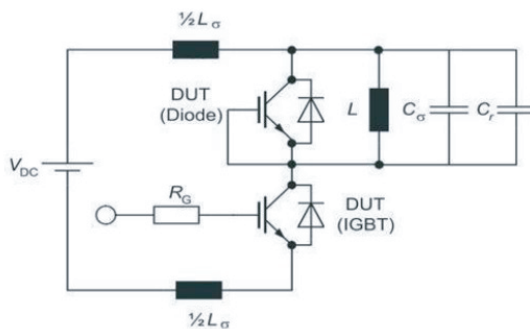


Figure 12. Transient Thermal Resistances

TEST CIRCUIT

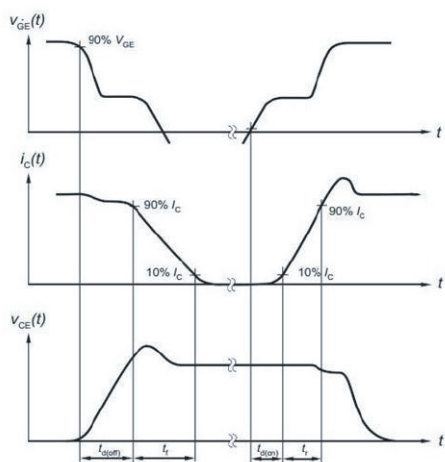


Gate Charge Test Circuit

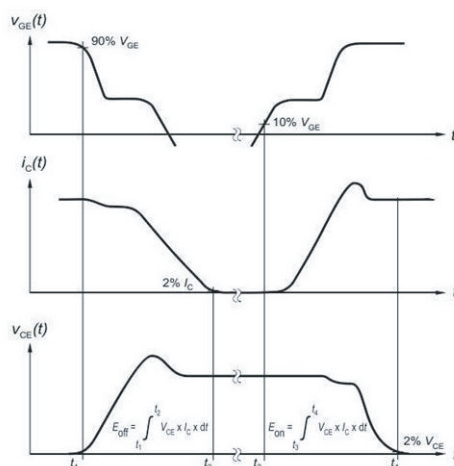


Switch Time Test Circuit

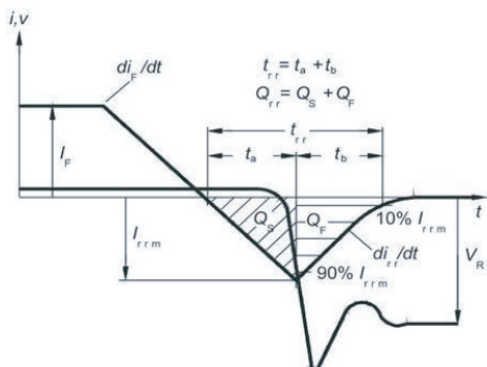
SWITCHING CHARACTERISTICS



Definition of switching times



Definition of switching losses



Definition of diode switching characteristics